

Low Pass Filter SMT

LFCV-ED13423/1

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



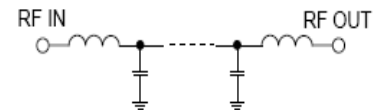
Please click "Back", and then click "Contact Us" for Applications support.

CASE STYLE : JV1210C

ELECTRICAL SPECIFICATIONS 50Ω @ +25°C							
Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Pass Band	Insertion Loss	DC-F1	DC-45	--	--	1.2	dB
	Freq. Cut-off	F2	77	--	3	--	dB
	VSWR	DC-F1	DC-45	--	1.2	--	:1
Stop Band	Rejection Loss	F3	120	20	--	--	dB
		F4-F5	150-910	--	40	--	dB
		F6	1100	--	20	--	dB
	VSWR	F3-F6	120-1100	--	20	--	:1

MAXIMUM RATINGS	
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
RF Power Input	8.5W max.

Functional Schematic



PIN CONNECTIONS	
RF IN	1
RF OUT	3
GROUND	2,4

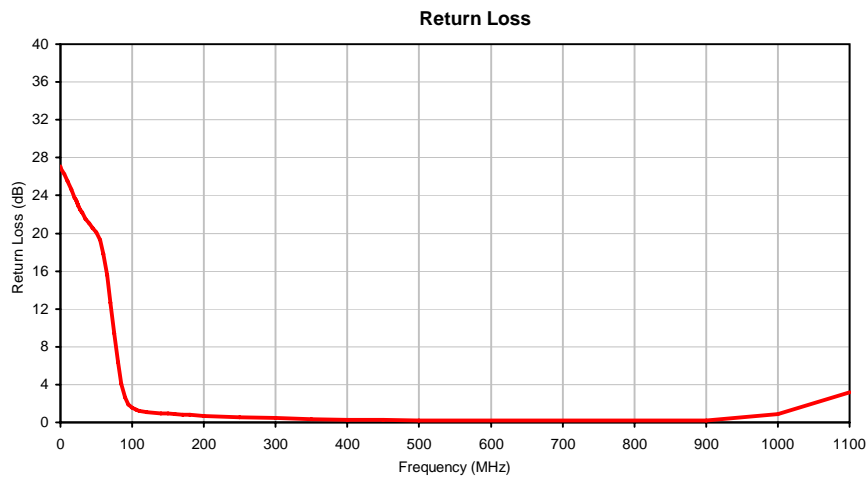
Low Pass Filter

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Typical Performance Data

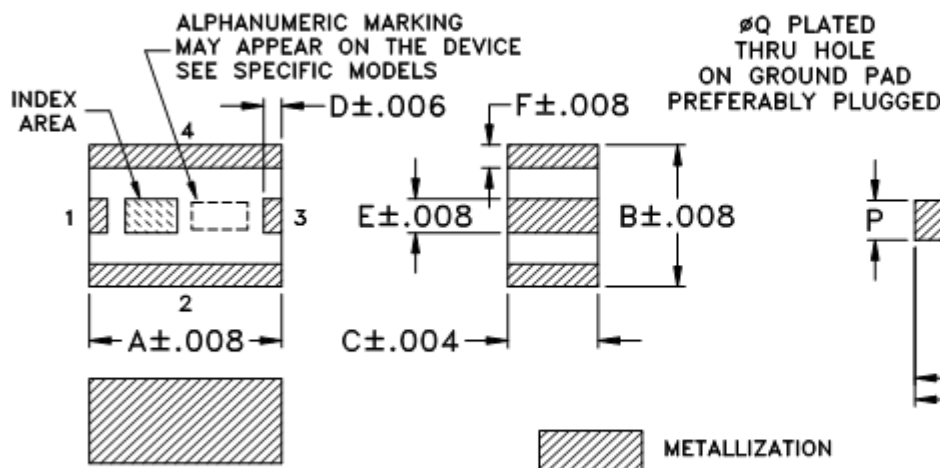
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.3	0.42	27.05
1.0	0.42	26.81
5.0	0.45	26.27
10.0	0.49	25.51
15.0	0.54	24.64
20.0	0.60	23.74
21.0	0.62	23.57
22.0	0.63	23.40
23.0	0.65	23.23
24.0	0.66	23.06
25.0	0.68	22.90
26.0	0.69	22.74
27.0	0.71	22.60
28.0	0.73	22.45
29.0	0.74	22.30
30.0	0.76	22.17
35.0	0.85	21.55
40.0	0.95	21.05
45.0	1.05	20.60
50.0	1.15	20.09
55.0	1.28	19.27
60.0	1.43	17.83
65.0	1.65	15.59
70.0	2.01	12.65
75.0	2.66	9.38
80.0	3.86	6.35
85.0	5.87	4.06
90.0	8.67	2.65
95.0	11.96	1.90
100.0	15.38	1.53
105.0	18.75	1.33
110.0	21.94	1.23
115.0	24.91	1.16
120.0	27.64	1.11
130.0	32.42	1.03
140.0	36.43	0.97
150.0	39.88	0.92
160.0	43.05	0.87
170.0	46.16	0.83
180.0	49.45	0.78
190.0	53.36	0.74
200.0	58.53	0.70
250.0	55.12	0.54
300.0	50.68	0.44
350.0	49.58	0.36
400.0	49.60	0.30
450.0	50.14	0.26
500.0	51.01	0.23
600.0	54.02	0.20
700.0	60.72	0.18
800.0	58.31	0.18
900.0	41.65	0.21
1000.0	20.25	0.91
1100.0	12.04	3.17

Typical Performance Curves

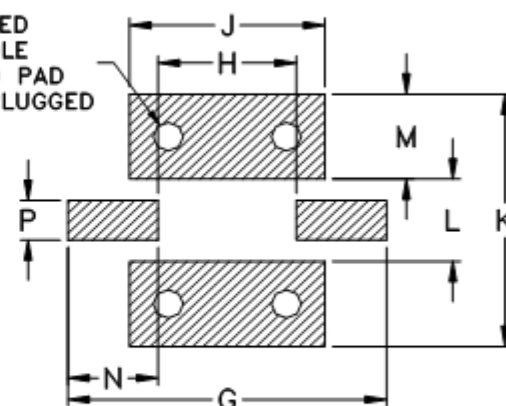


Outline Dimensions

JV1210C



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	Q	WT. GRAM
JV1210C	.126 (3.2)	.098 (2.5)	.059 (1.5)	.012 (.3)	.024 (.6)	.016 (.4)	.209 (5.3)	.091 (2.3)	.128 (3.25)	.175 (4.45)	.057 (1.45)	.059 (1.5)	.059 (1.5)	.028 (.7)	.020 (.5)	.03

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

1. Open style, ceramic base.
2. Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
3. Pad tolerance is non-cumulative. Minimum spacing between each pad is .004.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F74

DEVICE ORIENTATION IN T&R

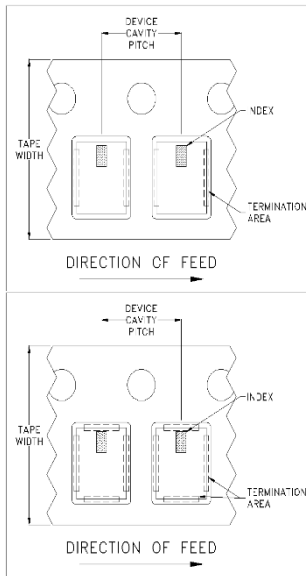


ILLUSTRATION 1

Applicable Case Styles

GE0805C-1
GE0805C-1AP
JV1210C-1
GU2939

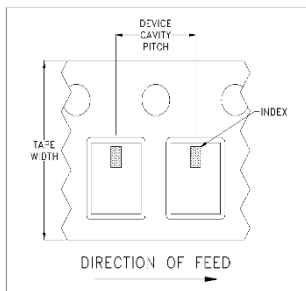


ILLUSTRATION 2

Applicable Case Styles

JV1210C
JV1210C-2
JV1210C-3
JV1210C-4
JV1210C-5
JV1210C-6
JV1210C-11

ILLUSTRATION 3

Applicable Case Styles

JC0603C-8
JC0603C-9
JV1210C-7
JV1210C-8
JV1210C-9
JV1210C-10
JV1210C-13
GE0805C-13
GE0805C-19
GE0805C-20

Tape Width, mm	Device Cavity Pitch, mm	Real Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	2000
				4000

Note: Small reel availability varies by model. Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

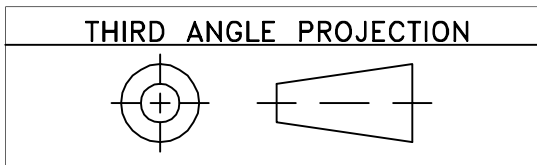


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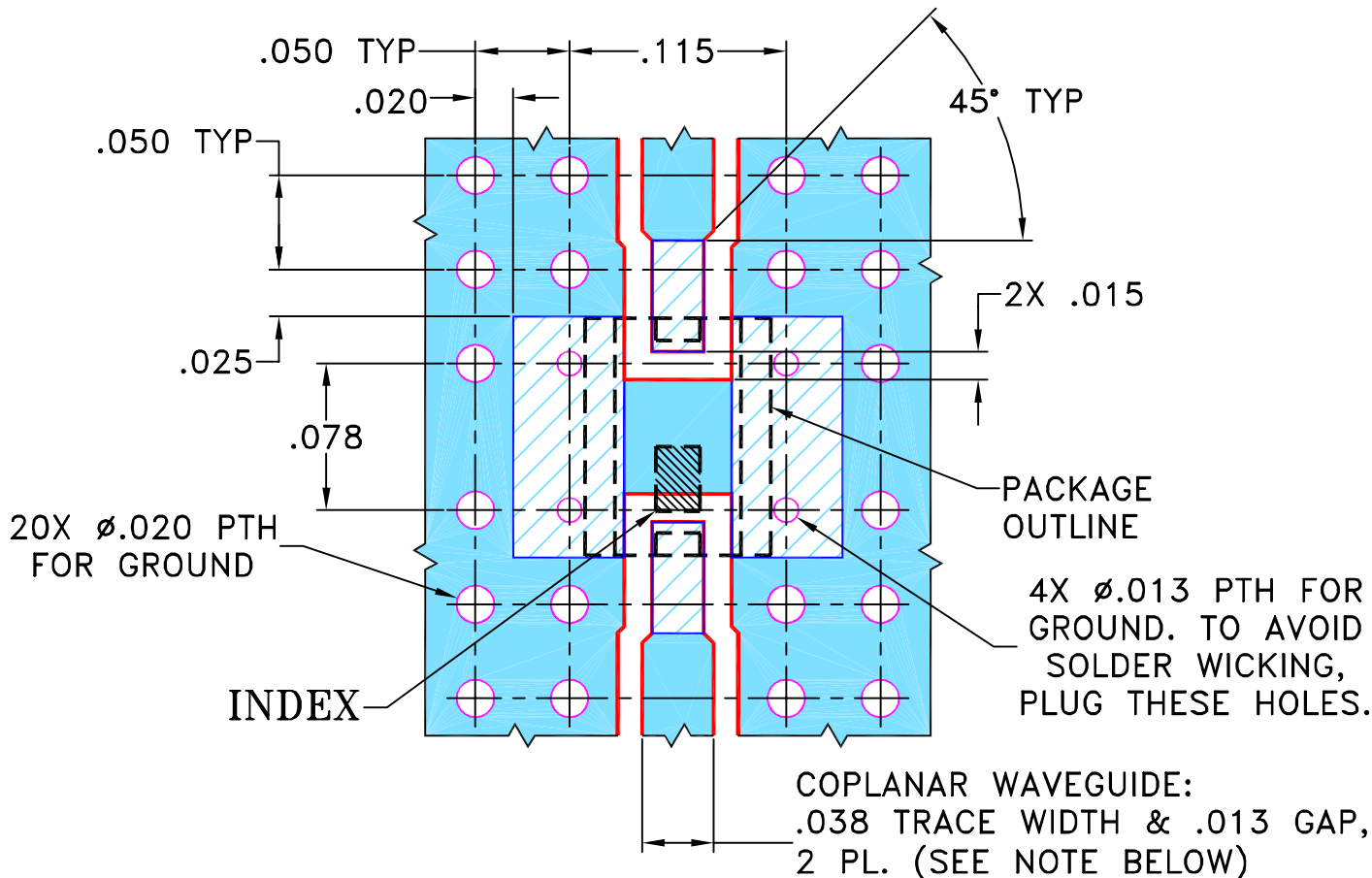
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REVISIONS					
REV OR	ECN No.	DESCRIPTION	DATE	DR	AUTH
	M123026	NEW RELEASE	06/08/09	PW	ABD

**SUGGESTED MOUNTING CONFIGURATION
FOR JV1210C CASE STYLE, "04FL01" PIN CONNECTIONS**

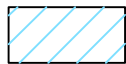


NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.020" ± 0.0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN PW	05/27/09
TOLERANCES ON:	CHECKED IL	06/04/09
2 PL DECIMALS ±	APPROVED ABD	06/08/09
3 PL DECIMALS ± .005		
ANGLES ±		
FRACTIONS ±		



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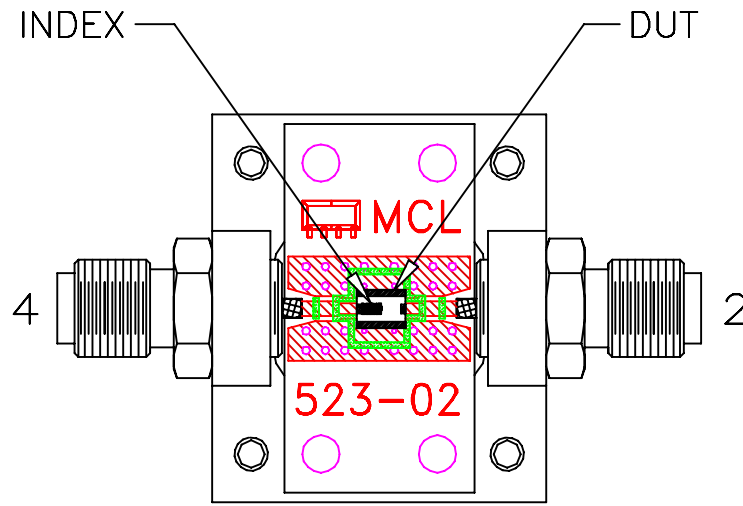
13 Neptune Avenue
Brooklyn NY 11235

PL, 04FL01, JV1210C, LFCF, TB-526+

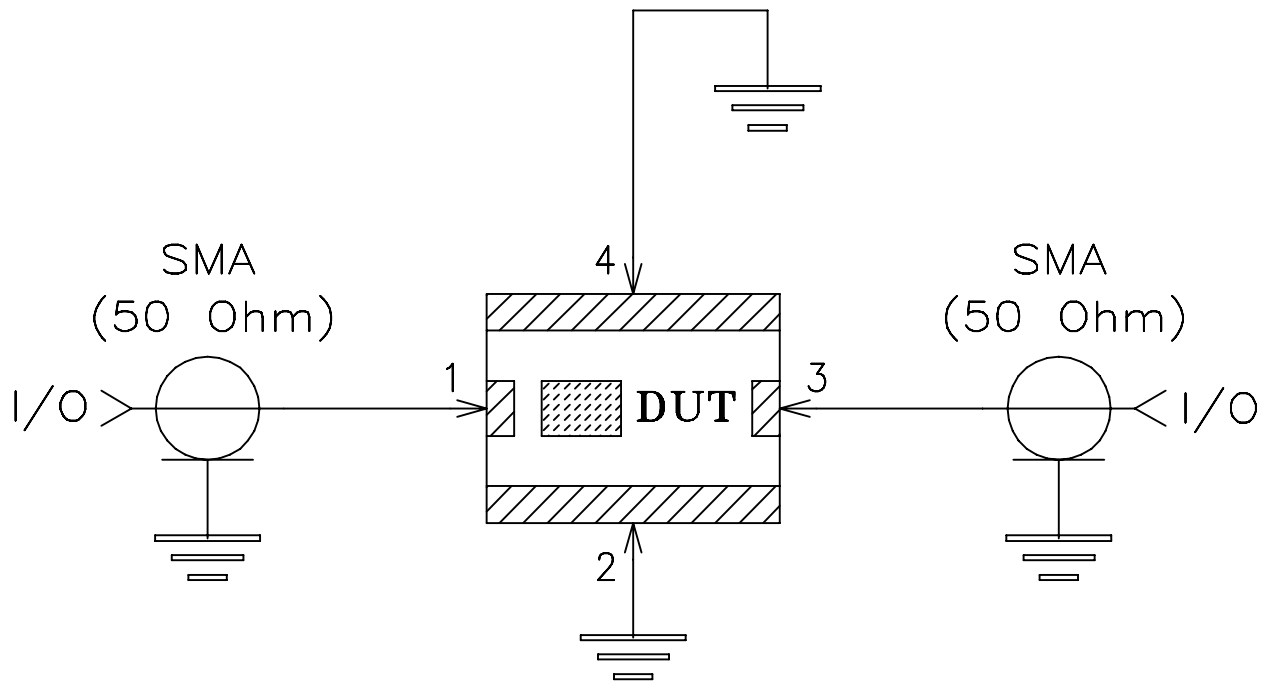
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SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-307	REV: OR
FILE: 98PL307	SCALE: 10:1	SHEET: 1 OF 1	

Evaluation Board and Circuit




TB-526+



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 Mini-Circuits®

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A